

FIG. 1

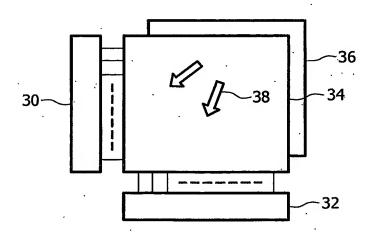


FIG. 2

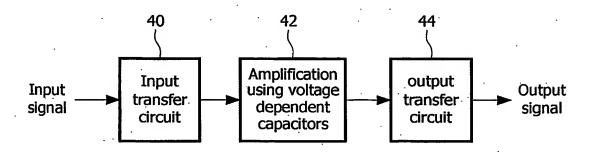


FIG. 3

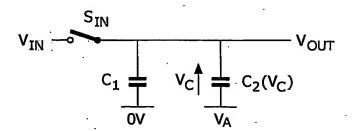


FIG. 4

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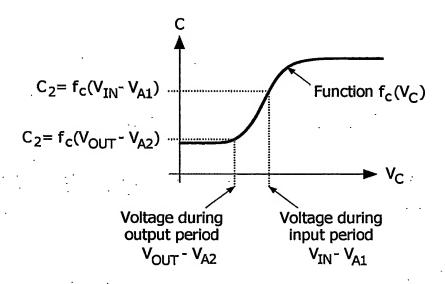


FIG. 5

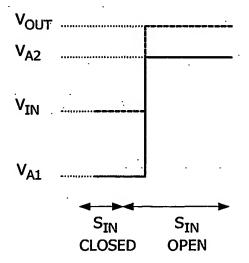


FIG. 6

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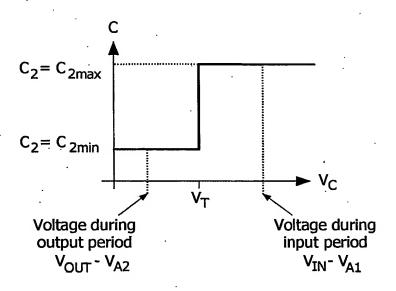


FIG. 7

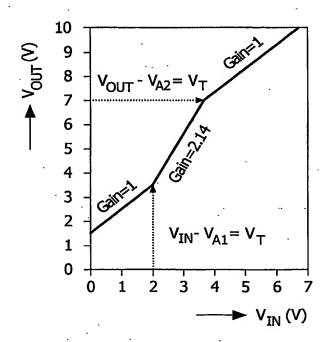


FIG. 8

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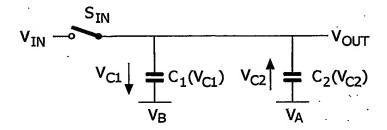


FIG. 9

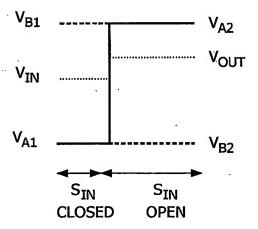


FIG. 10

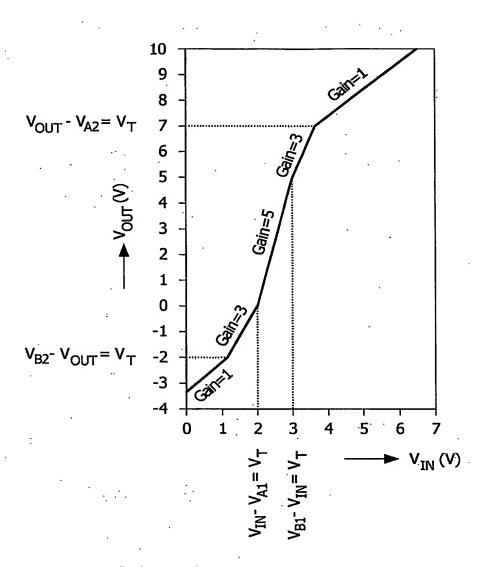


FIG. 11

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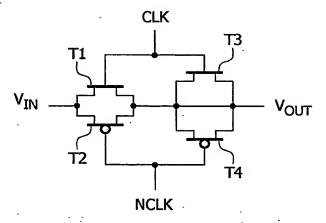
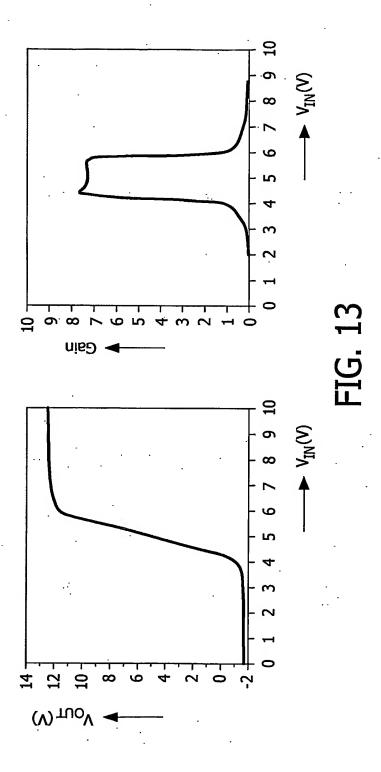


FIG. 12

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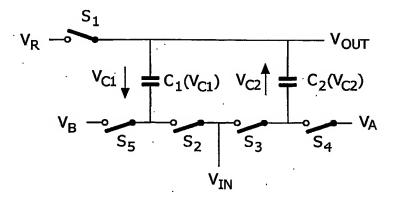


FIG. 14

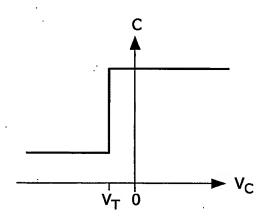
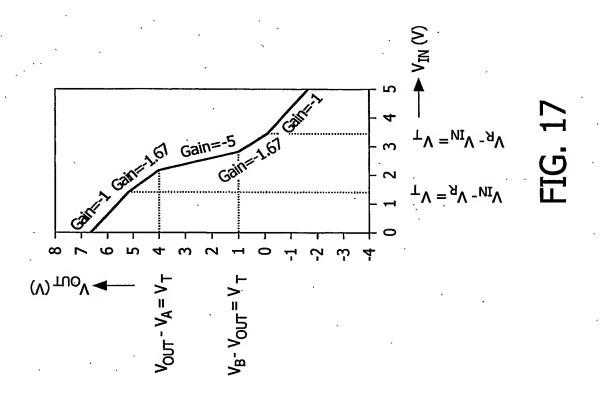
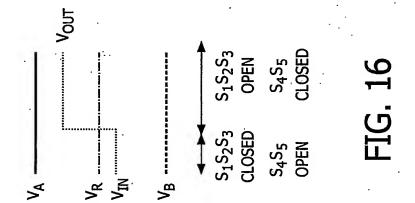


FIG. 15

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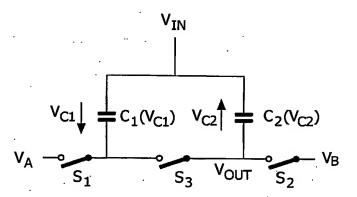


FIG. 18

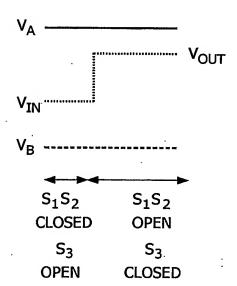
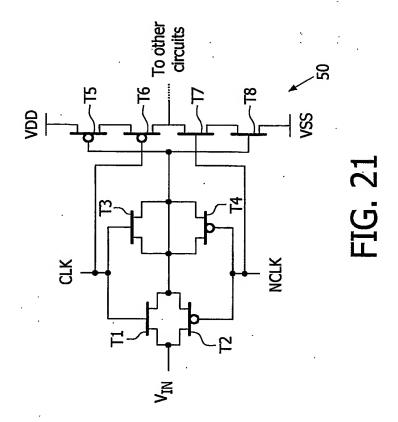
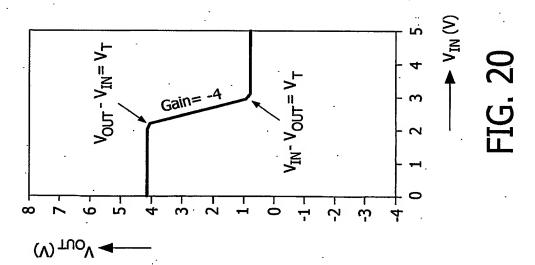


FIG. 19

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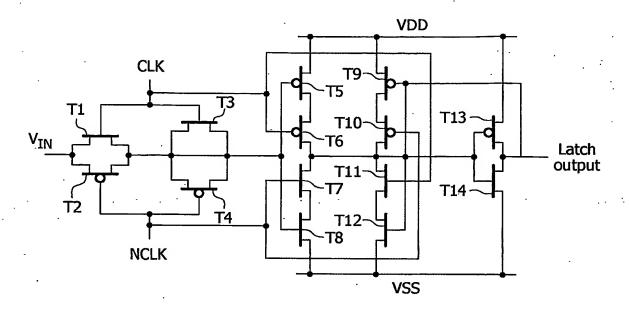


FIG. 22

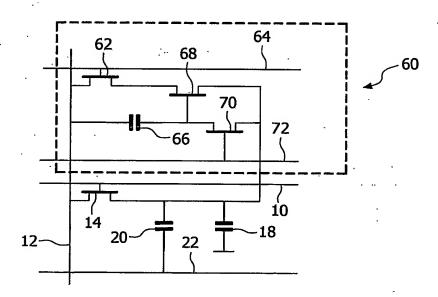


FIG. 23

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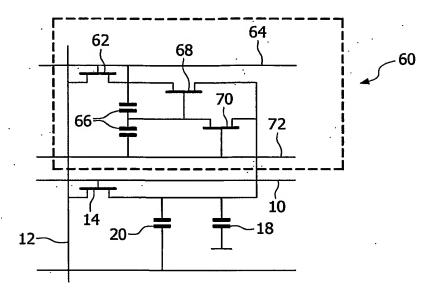


FIG. 24

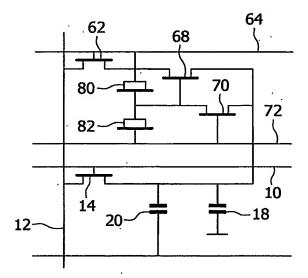


FIG. 25